

October 29, 2026

Company name: IBIDEN CO., LTD.

Representative: Koji Kawashima, President & CEO, Representative Director

Stock exchange listings: Tokyo and Nagoya Stock Exchange (Code number: 4062)

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Notice Regarding Capital Investment for High-Performance IC Package Substrates **(Acquisition of Fixed Assets)**

IBIDEN CO., LTD. (hereinafter “the Company”) hereby announces that the Board of Directors, at a meeting held today, resolved to implement capital investment, primarily at the Gama Plant Factory Building (Cell6), with the aim of increasing production capacity for high-performance IC package substrates, mainly for AI servers.

1. Outline of Capital investment

Gama Plant and other overseas plant

<Place>	Gama Plant (3-200, Gama-cho, Ogaki-city, Gifu Prefecture) and other overseas plant
<Investment Amount>	Approximately 151 billion yen (planned)
<Operation Start>	Sequential operation and planned commencement of mass production from fiscal year 2029
<Production Capacity>	Through this investment, the Company will increase the production capacity for high-performance IC package substrates for CPUs, for which demand is expected to increase as AI evolves from learning-type to inference-type and further to agentic AI.

2. Future Outlook

The impact of this investment on the Company's consolidated financial results for the current fiscal year is expected to be immaterial.

End